

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

Baglee, D.,

Atty. Docket No.: 303.378US1 Applicant: Leonard Forbes et al.

Sheet 1 of 7 Serial No. 08/903,453

(Use several sheets if necessary) Filing Date: July 29, 1997

Group: 1104

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Sheet 2 of 7 Atty. Docket No.: 303.378US1 Serial No. 08/903,453 Applicant: Leonard Forbes et al. Filing Date: July 29, 1997 Group: 1104

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Sheet 5 of 7 Serial No. 08/903,453

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Attu Destant	Sheet 6 of		
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